

## 40V N-Channel Enhancement Mode MOSFET

### Description

The NP55N04D6 uses Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

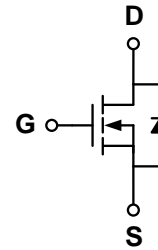
### General Features

- ◆  $V_{DS} = 40V$ ,  $I_D = 55A$   
 $R_{DS(ON)}(Typ.) = 8\ m\Omega$  @  $V_{GS} = 10V$   
 $R_{DS(ON)}(Typ.) = 11\ m\Omega$  @  $V_{GS} = 4.5V$
- ◆ Very low on-resistance  $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

### Application

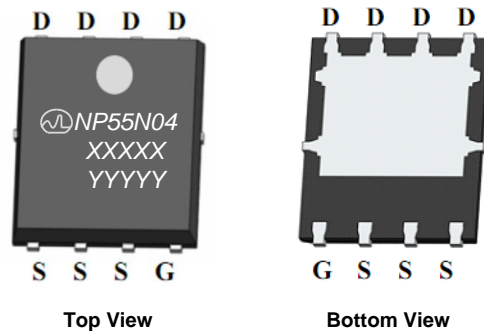
- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications

### Schematic diagram



### Marking and pin assignment

#### PDFN5\*6-8L-A



XXXX—Wafer Information  
 YYYY—Quality Code

### Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
NP55N04D6-G	-55°C to +150°C	PDFN5*6-8L-A	5000

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit	
Drain-source voltage	$V_{DS}$	40	V	
Gate-source voltage	$V_{GS}$	±20	V	
Continuous Drain Current	$I_D$	TC=25°C	55	A
		TC=70°C	40	
Avalanche energy ( $T_j = 25^\circ C$ , $V_{DD} = 40V$ , $V_G = 10V$ , $L = 0.5mH$ , $R_g = 25\Omega$ )		$E_{AS}$	150	mJ
Power Dissipation	$P_D$	TC=25°C	48	W
		TC=70°C	30	
Operating junction Temperature range		$T_j$	-55—150	°C

**Electrical Characteristics** (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	40	-	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=40V, V_{GS}=0V$	-	-	1	$\mu A$
		$T_J=55^\circ C$	-	-	5	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	2.5	V
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=20A$	-	8	9	m $\Omega$
		$V_{GS}=4.5V, I_D=20A$	-	11	16	
Forward Transconductance	$g_{FS}$	$V_{DS}=20V, I_D=20A$	-	100	-	S
<b>Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$I_{SD}=1A, V_{GS}=0V$	-	0.7	1.2	V
Diode Continuous Forward Current	$I_S$		-	-	55	A
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ C, I_F = I_S,$ $di/dt = 100A/\mu s$	-	24.5	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	42	-	nC
<b>Dynamic Characteristics</b>						
Gate Resistance	$R_G$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	-	-	2.9	$\Omega$
Input capacitance	$C_{ISS}$	$V_{GS}=0V, V_{DS}=20V$ $f=1.0MHz$	-	1590	-	pF
Output capacitance	$C_{OSS}$		-	125	-	
Reverse transfer capacitance	$C_{RSS}$		-	109	-	
Turn-on delay time	$t_{D(ON)}$	$V_{GS}=10V, V_{DS}=20V, R_L=1.5\Omega,$ $R_G=3\Omega$	-	13	-	ns
Turn-on Rise time	$t_r$		-	4	-	
Turn-off delay time	$t_{D(OFF)}$		-	47	-	
Turn-off Fall time	$t_f$		-	6.5	-	
Total gate charge	$Q_g$	$V_{GS}=10V, V_{DS}=20V, I_D=20A$	-	32.5	-	nC
Gate-source charge	$Q_{gs}$		-	5.2	-	
Gate-drain charge	$Q_{gd}$		-	6.7	-	

**Thermal Characteristics**

Parameter	Symbol	Typ	Max	Unit
Maximum Junction-to-Lead	Steady-State $R_{\theta JC}$	2.1	2.6	$^\circ C/W$

The value of  $R_{\theta JC}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10s$  thermal resistance rating.

The  $R_{\theta JC}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

## Typical Performance Characteristics

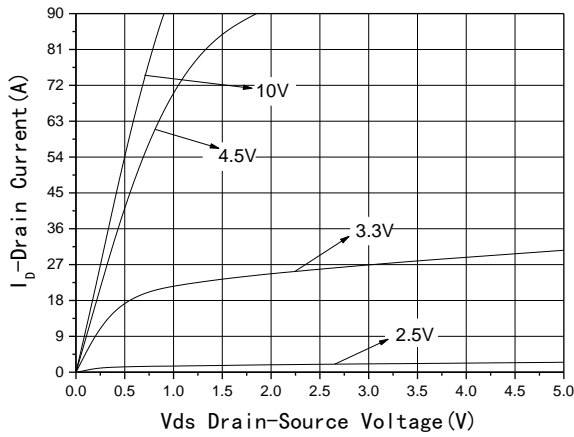


Fig1 Output Characteristics

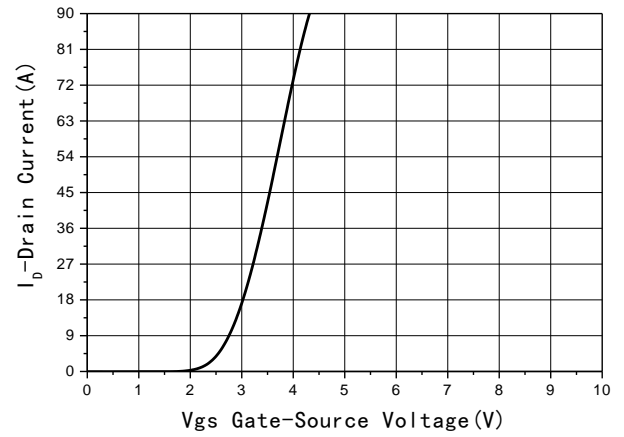


Fig2 Transfer Characteristics

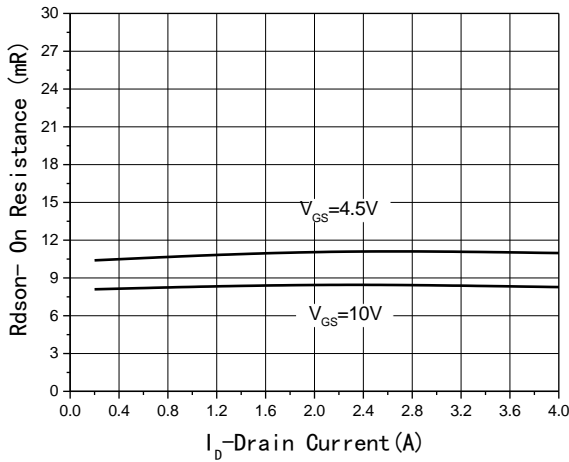


Fig3  $R_{DS(on)}$ -Drain current

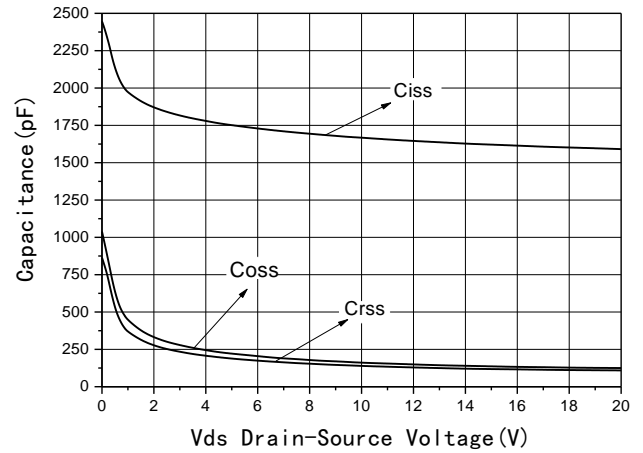


Fig4 Capacitance vs  $V_{DS}$

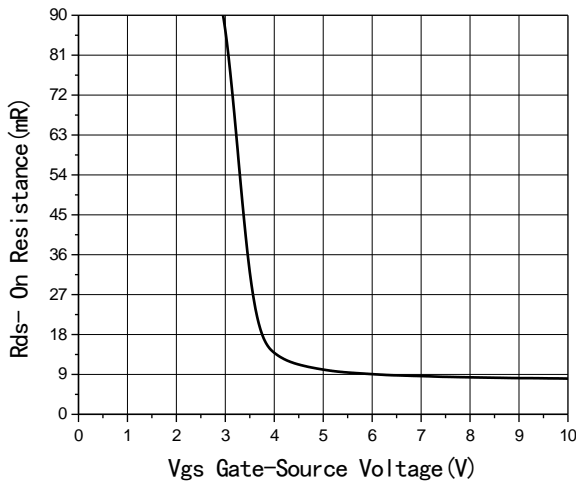


Fig5  $R_{DS(on)}$ -Gate Drain voltage

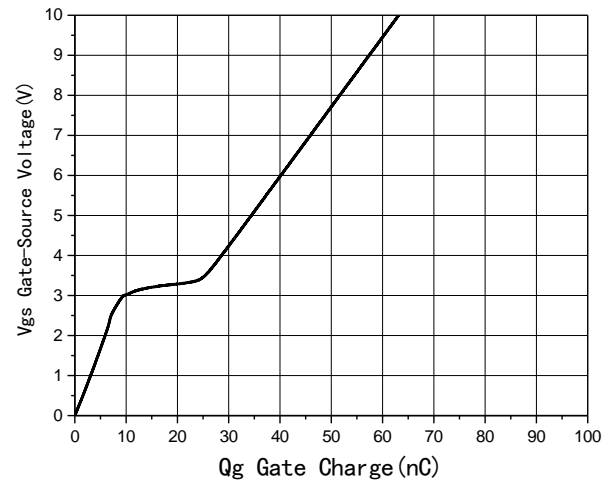
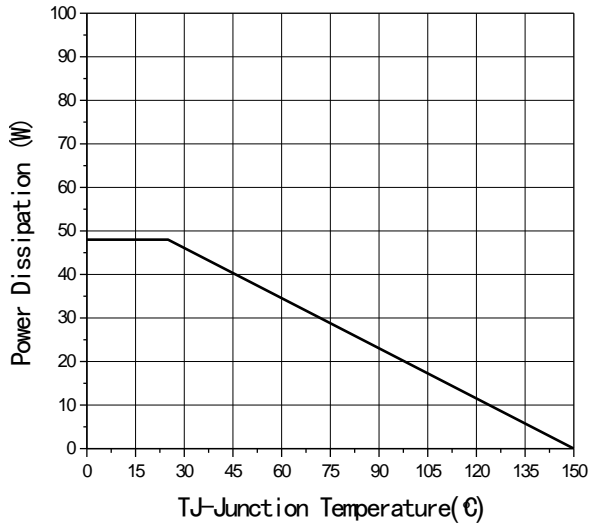
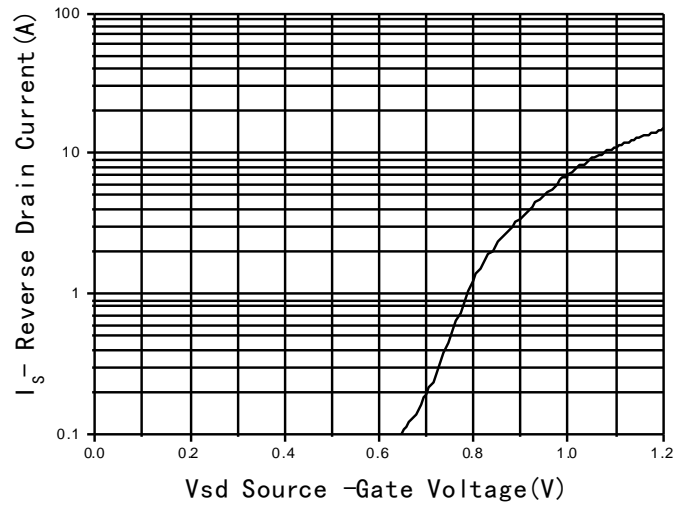


Fig6 Gate Charge



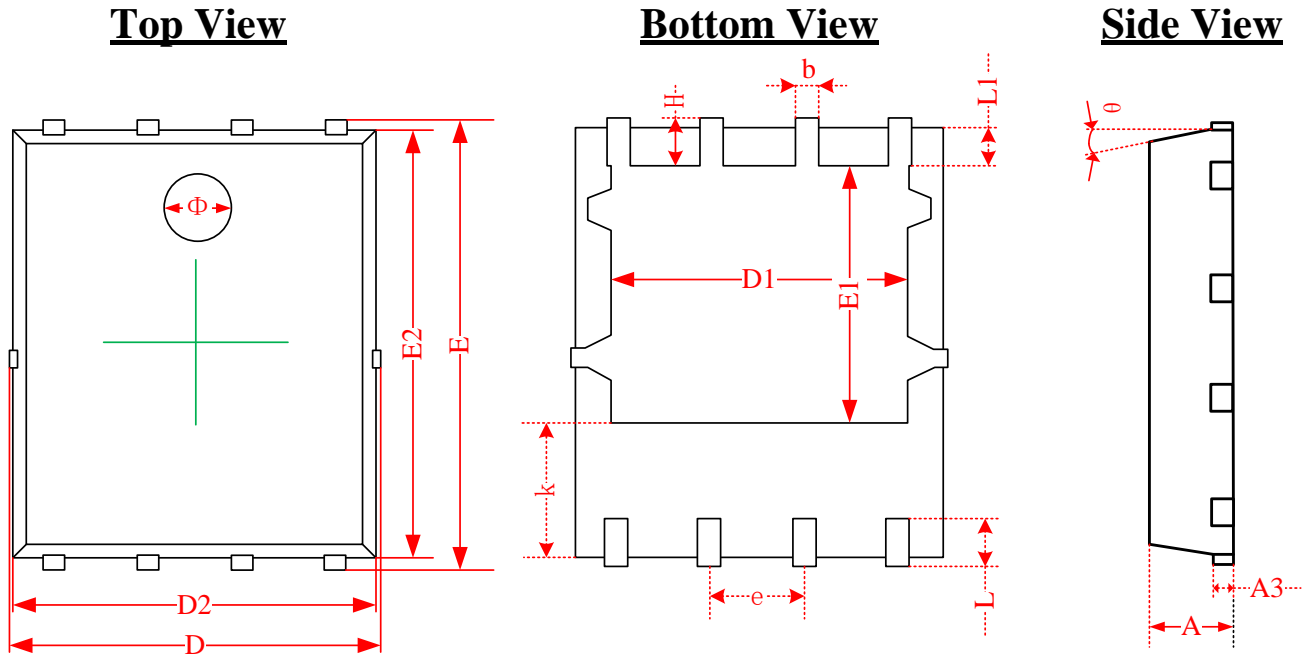
**Fig7 Power De-rating**



**Fig8 Source-Drain Diode Forward**

## Package Information

- PDFN5\*6-8L-A



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.870	0.900	0.930	0.034	0.035	0.036
A3	0.152REF.			0.006REF.		
D	4.944	5.020	5.096	0.195	0.198	0.201
E	5.974	6.050	6.126	0.235	0.238	0.241
D1	3.910	4.010	4.110	0.154	0.158	0.162
E1	3.375	3.475	3.575	0.133	0.137	0.141
D2	4.870	4.900	4.930	0.192	0.193	0.194
E2	5.720	5.750	5.780	0.226	0.227	0.228
k	1.190	1.290	1.390	0.047	0.051	0.055
b	0.350	0.380	0.410	0.014	0.015	0.016
e	1.270TYP.			0.050TYP.		
L	0.559	0.635	0.711	0.022	0.025	0.028
L1	0.424	0.500	0.576	0.017	0.020	0.023
H	0.574	0.650	0.726	0.023	0.026	0.029
$\theta$	10°	11°	12°	10°	11°	12°
$\Phi$	1.150	1.200	1.250	0.045	0.047	0.049

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